

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT4437730

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	LI-CHE CHEN	05/22/2017
	CHIEN-WEI CHIU	05/22/2017
	CHIEN-HSIEN SONG	05/22/2017
RECEIVING PARTY DATA		
Name:	VANGUARD INTERNATIONAL SEMICONDUCTOR CORPORATION	
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City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	30077	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	15607976	
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ATTORNEY DOCKET NUMBER:	0941-3565PUS1	
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SIGNATURE:	/analiza stepina/	
DATE SIGNED:	05/31/2017	
Total Attachments: 1		
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ASSIGNMENT

WHEREAS, Li-Che CHEN, Chien-Wei CHIU, and Chien-Hsien SONG hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: SEMICONDUCTOR DEVICES AND METHODS FOR MANUFACTURING THE SAME

Filed: 30-MAY-2017 Serial No. 15/607,976

Executed on: _____

WHEREAS, Vanguard International Semiconductor Corporation of 123, Park Ave-3rd, Science - Based Industrial Park, Hsinchu, Taiwan 30077, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Li che chen
Li-Che CHEN

2017.05.22
Date

Chien-Wei CHIU
Chien-Wei CHIU

2017.05.22
Date

Chien Hsien Song
Chien-Hsien SONG

2017.05.22
Date